

## PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Soo-Byung KO</td><td>08/29/2011</td></tr><tr><td>Kee-Joon OH</td><td>08/29/2011</td></tr><tr><td>Sung-Hyun YOON</td><td>08/29/2011</td></tr><tr><td>Soon-Young PARK</td><td>08/29/2011</td></tr></tbody></table>	Name	Execution Date	Soo-Byung KO	08/29/2011	Kee-Joon OH	08/29/2011	Sung-Hyun YOON	08/29/2011	Soon-Young PARK	08/29/2011	
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Sung-Hyun YOON	08/29/2011										
Soon-Young PARK	08/29/2011										
RECEIVING PARTY DATA											
Name:	Hynix Semiconductor Inc.										
Street Address:	San 136-1, Ami-ri, Bubal-eup, Icheon-si,										
City:	Gyeonggi-do,										
State/Country:	REPUBLIC OF KOREA										
Postal Code:	467-701										
PROPERTY NUMBERS Total: 1											
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>13240340</td></tr></tbody></table>	Property Type	Number	Application Number:	13240340							
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Application Number:	13240340										
CORRESPONDENCE DATA											
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ATTORNEY DOCKET NUMBER:	P10H0109/US										
NAME OF SUBMITTER:	Jung H. Kim										
Total Attachments: 2 source=P10H0109US-Assignment#page1.tif source=P10H0109US-Assignment#page2.tif											

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PATENT  
REEL: 026949 FRAME: 0686

## ASSIGNMENT OF PATENT APPLICATION

WHEREAS I/We, the below named inventor(s) has made an invention entitled:  
METHOD FOR FABRICATING SEMICONDUCTOR DEVICE

For which I/We executed an application for Letters Patent of the United States concurrently herewith; and/or  
For which I/We filed an application for Letters Patent of the United States on \_\_\_\_\_ (Application No. \_\_\_\_\_),

BE IT KNOWN that, for good and valuable consideration, the receipt of which is hereby acknowledged, I/We, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto Hynix Semiconductor Inc., a corporation of the Republic of Korea, whose post office address is San 136-1, Ami-ri, Bubal-eup, Icheon-si, Gyeonggi-do 467-701, Republic of Korea (hereinafter referred to as Assignee), its lawful successors and assigns my/our entire right, title, and interest in and to this application and the invention(s) and improvement(s) set forth therein; and any and all continuations, continuations-in-part, divisionals, and renewals of and substitutes for said application for said Letters Patent and any and all Letters Patent of the United States and of countries foreign thereto, which may be granted thereon or therefore; and any reissues, reexaminations, or extensions of all such Letters Patent.

I/WE HEREBY authorize the Assignee, its lawful successors and assigns to apply for Letters Patent in all countries foreign to the United States directly in its own name, and to claim priority of the filing date of any of the above-mentioned applications for Letters Patent of the United States and of countries foreign thereto under the provisions of any and all international conventions and treaties.

I/WE HEREBY authorize and request the Commissioner of Patents and Trademarks of the United States and official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as foresaid, to issue all Letters Patent for this invention to the Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with said Assignee, its successors and assigns, any facts known to me/us respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid said Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and in countries foreign thereto, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys of record to insert the serial number and filing date of said application now identified by the attorney docket number and title set forth above as soon as the same shall have been known to them by the United States Patent and Trademark Office.

IN TESTIMONY WHEREOF, I/We have hereunto set our hands.

Signature of first assignor:

Name of first assignor:

Address:

Ko, Soo-Byung Date August 29, 2011  
KO, Soo-Byung  
San 136-1, Ami-ri, Bubal-eup, Icheon-si, Gyeonggi-do 467-701, Republic of Korea

Signature of second assignor:

Name of second assignor:

Address:

OH, Kee-Joon Date August 29, 2011  
OH, Kee-Joon  
San 136-1, Ami-ri, Bubal-eup, Icheon-si, Gyeonggi-do 467-701, Republic of Korea

Signature of third assignor:  
Name of third assignor:  
Address:

Yoon, Sung-Hyun

Date August 29, 2011

YOON, Sung-Hyun

San 136-1, Ami-ri, Bubal-eup, Icheon-si, Gyeonggi-do 467-701, Republic of Korea

Signature of fourth assignor:  
Name of fourth assignor:  
Address:

PARK, Soon-Young

Date August 29, 2011

PARK, Soon-Young

San 136-1, Ami-ri, Bubal-eup, Icheon-si, Gyeonggi-do 467-701, Republic of Korea

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